



德砚电子

DE YAN DIAN ZI

一体成型功率电感

Data Sheet

RoHS



ISO 9001
质量管理体系认证



ISO 14001
环境管理体系认证

Shenzhen Deyan Electronics Co., Ltd

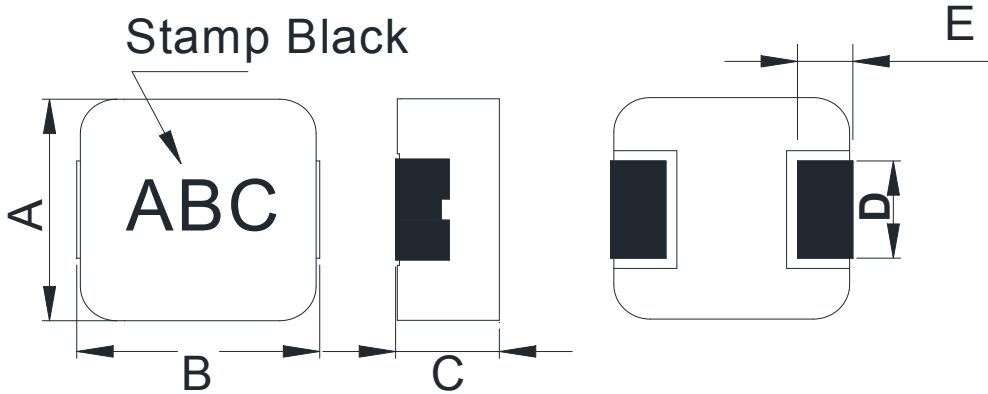
SPECIFICATION

| | | | AMENDMENT RECORD | | | |
|--------|------|------|-------------------------|---------|---------|---------|
| SYMBOL | DATE | PAGE | CONTENTS | DWN. BY | CHK. BY | APP. BY |
| | | | | 叶枫 | 李林 | 谢东 |
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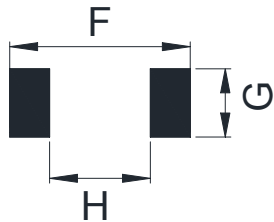
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1. DIMENSIONS (UNIT : mm)



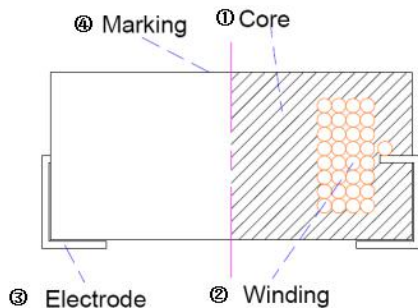
| A | B | C | D | E |
|----------|----------|----------|---------|---------|
| 12.6±0.2 | 13.8 Max | 6.5 Max. | 3.7±0.5 | 2.7±0.5 |

2. RECOMMENDED LAND PATTERN (UNIT: mm)



| | |
|---|-----------|
| F | 14.5 Ref. |
| G | 5.0 Ref. |
| H | 6.5 Ref. |

3. STRUCTURE



| No. | PARTS | MATERIAL |
|-----|-----------|---|
| ① | CORE | Alloy powder |
| ② | WIRE | Self bonding polyamide-imide enameled Copper Wire |
| ③ | ELECTRODE | Cu |
| ④ | MARKING | INK |

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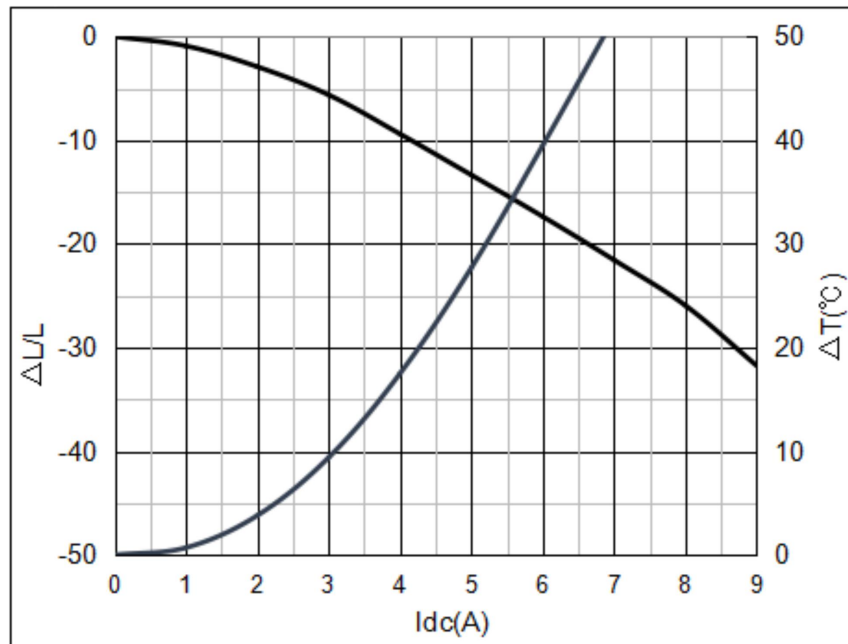
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4.CHARACTERISTICS

| No. | P/N. | Inductance (μ H) | Stamp | D.C.R. (m Ω) Max. | Saturation Current (A) | | Temperature rise current($\Delta T \leq 40^\circ\text{C}$) (A). | |
|-----|---------------|-----------------------|-------|---------------------------|------------------------|-----|---|-----|
| | | | | | Typ | MAX | Typ | MAX |
| 01 | D1265HP-220MT | 22 \pm 20% | 220 | 44 | 7.5 | 6.4 | 5.8 | 5.0 |

- * Testing instrument: Inductance HP 4284A or equivalent at 100KHz /1V..
D.C.R : TH2512B or equivalent. (Ta= 25 $^\circ\text{C}$)
Saturation current: WK 3260B+3265B or equivalent.
- * Saturation current: indicates the current when the inductance decrease to approximately 70% of initial value. (Ta=25 $^\circ\text{C}$)
- * The temperature rise current value is the DC current value having temperature increase up to approximately 40 $^\circ\text{C}$ (Ta=25 $^\circ\text{C}$)
- * Absolute maximum voltage 30VDC

220 DC Bias & Temperature Characteristics



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5. GENERAL CHARACTERISTICS

* STANDARD TESTING CONDITIONS:

UNLESS OTHERWISE SPECIFIED, THE STANDARD RANGE OF ATMOSPHERIC CONDITIONS FOR MEASUREMENTS AND TESTS ARE AS FOLLOWS: AMBIENT TEMPERATURE: 15°C~35°C.

RELATIVE HUMIDITY : 25% ~85%. AIR PRESSURE : 86kPa ~106kPa.

IF THERE IS ANY DOUBT ABOUT THE RESULTS, MEASUREMENT SHALL BE MADE WITHIN THE FOLLOWING LIMITS: AMBIENT TEMPERATURE: 20°C±1°C. RELATIVE HUMIDITY: 63% ~67%.

AIR PRESSURE : 86kPa ~106kPa.

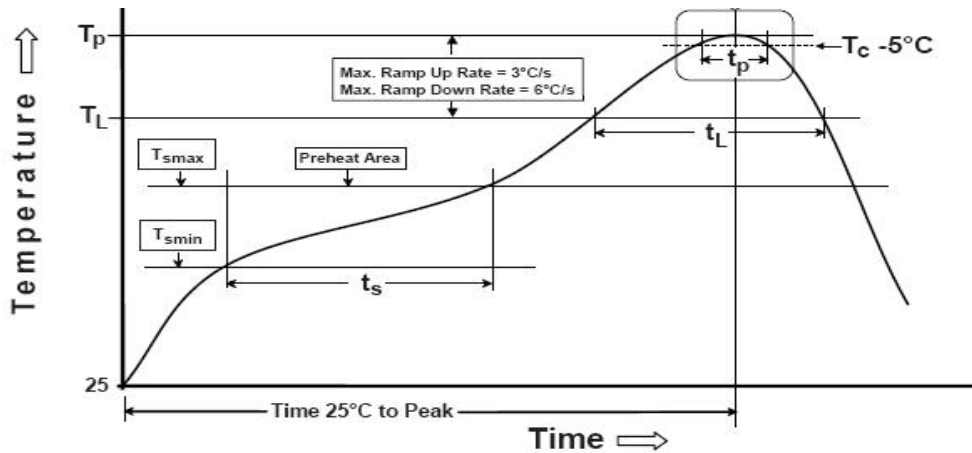
| No. | ITEMS | CONDITIONS | SPECIFICATION |
|-----|--|---|--|
| 1 | OPERATION TEMPERATURE STORAGE TEMPERATURE | | -40 ~ + 125°C (INCLUDING COIL TEMPERATURE RISE) -40 ~ + 125°C |
| 2 | TEMPERATURE COEFFICIENT | -30 ~ +105°C | 0 ~ 2000 ppm/°C |
| 3 | FIXING STRENGTH | SAMPLE IS PUSHED IN THREE DIRECTIONS OF X, Y AND Z WITH FORCE OF 5. 0N FOR 10±5 SECONDS. AFTER SOLDERING BETWEEN COPPER PLATE AND ELECTRODES. | NO ELECTRODE DETACHMENT. |
| 4 | RESISTANCE TO SOLDERING HEAT TEST | REFER TO THE SPEC "STD-001NP". | NO MECHANICAL BREAKAGE. DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10% |
| 5 | SOLDERABILITY TEST | IMMERSE THE ELECTRODE IN FLUX FOR 5 SECONDS. THEN DIP THE ELECTRODE INTO A SOLDERING BATH OF 245±5°C FOR 2±0.5 SECONDS. | OVER 95% OF THE SURFACE BEING IMMersed SHALL BE COVERED WITH NEW SOLDER UNIFORMLY. |
| 6 | VIBRATION TEST | AMPLITUDE: 1.5mm P-P FREQUENCY:10~55~10Hz (1 MINUTE PER CYCLE) DURATION: 1 HOUR IN EACH OF X, Y, Z AXIS. | DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10% |
| 7 | HUMIDITY TEST | TEMPERATURE: 40°C±2°C HUMIDITY: 90%~95%RH DURATION: 96±4 HOURS. | DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10% |
| 8 | THERMAL SHOCK TEST | 20 CYCLES OF +105°C FOR 30 MINUTES, -40°C FOR 30 MINUTES. CHARACTERISTICS ARE MEASURED AFTER THE AMBIENT AIR EXPOSURE OF 1 HOUR | DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10% |
| 9 | HIGH TEMPERATURE STORAGE TEST | TEMPERATURE: 125°C±2°C DURATION: 96±4 HOURS | |
| 10 | LOW TEMPERATURE STORAGE TEST | TEMPERATURE: -40°C±3°C DURATION: 96±4 HOURS. | |

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6. Reflow profile for SMT components



Reflow is referred to standard IPC/ JEDEC J-STD-020D

| | |
|---|-----------------------------|
| Profile Feature | Lead(Pb) Free solder |
| Preheat and soak | ·temperature Min.(Tsmmin) |
| | ·temperature Max.(Tsmmax) |
| | ·time(Tsmmin to Tsmmax)(ts) |
| Average ramp up rate Tsmmax to Tp | 3°C/Second Max. |
| Liquidous temperature (TL) | 217 °C |
| Time (TL) maintained above TL | 60-150 seconds |
| Peak package body temperature (Tp) | Table2 |
| Time (tp)* within 5 °C of the specified classification temperature (Tc) | 30* seconds |
| Average Ramp-down rate (Tp to TL) | 6 °C/second max |
| Time 25 °C to peak temperature | 8 minutes max. |

Table2. Pb-Free Process - Classification Temperatures (Tc)

| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350~2000 | Volume mm ³ >2000 |
|-------------------|--------------------------------|------------------------------------|---------------------------------|
| <1.6 mm | 260°C | 260°C | 260°C |
| 1.6mm- 2.5mm | 260°C | 250°C | 245°C |
| >2.5 mm | 250°C | 245°C | 245°C |

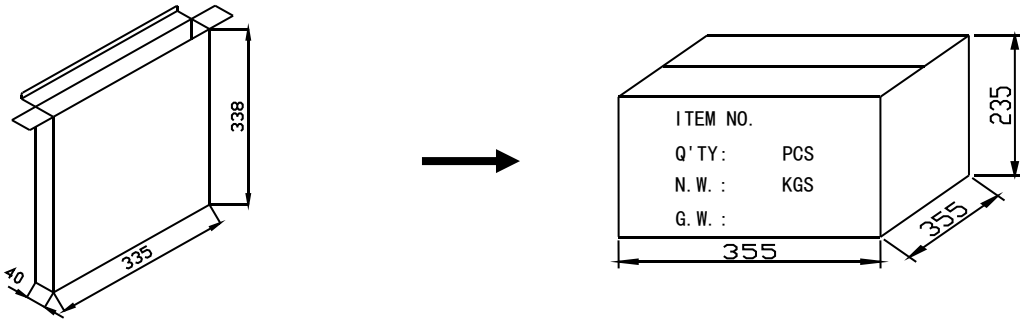
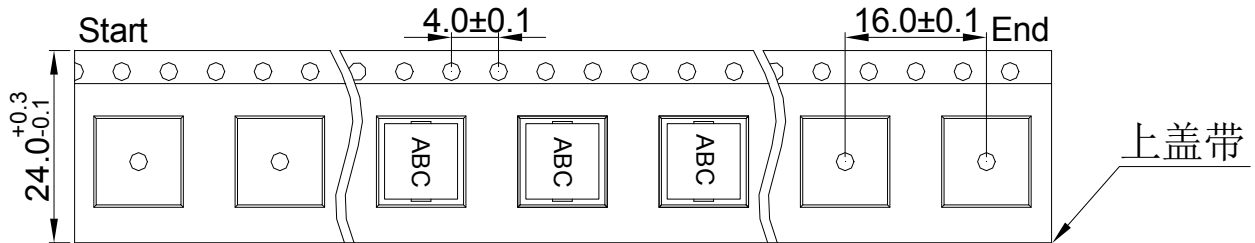
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7. PACKING

REFER TO STANDARD PACKING DRAWING. 500PCS/R



| | |
|------|---------|
| REEL | 500PCS |
| BOX | 2500PCS |

8. NOTE

SOLDERING TIN PERIOD OF VALIDITY: SIX MONTHS
 STORAGE TEMPERATURE: $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$
 COMPARATIVELY HUMIDITY: 35%--70%

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